



Europäisches Patentamt
European Patent Office
Office européen des brevets



Publication number:

0 520 677 A1

EUROPEAN PATENT APPLICATION

Application number: **92305547.9**

Int. Cl.⁵: **H05K 9/00**

Date of filing: **17.06.92**

Priority: **28.06.91 GB 9114060**

Date of publication of application:
30.12.92 Bulletin 92/53

Designated Contracting States:
AT BE CH DE DK ES FR GB GR IT LI NL PT SE

Applicant: **GRACE N.V.**
Nijverheidsstraat 7
B-2431 Westerlo(BE)

Inventor: **Pues, Hugo Franciscus**
Nijverheidsstraat 7
B-2260 Westerlo(BE)
Inventor: **Dauwen, Jan Marcel Angelina**
Nijverheidsstraat 7
B-2260 Westerlo(BE)
Inventor: **Timmerman, August Theophile**
Nijverheidsstraat 7
B-2260 Westerlo(BE)
Inventor: **van Craenendonck, Michael August**
Constantia
Nijverheidsstraat 7
B-2260 Westerlo(BE)

Representative: **Barlow, Roy James**
J.A. KEMP & CO. 14, South Square, Gray's
Inn
London WC1R 5LX(GB)

Chiral absorbing structure.

An absorbing assembly for absorbing electromagnetic radiation in the range 10MHz to 100 GHz comprises a lossy dielectric material and chiral elements disposed outside the lossy dielectric. The chiral elements may be springs, Möbius bands, irregular tetrahedra, tapering helical springs or handed non-planar forks. The lossy dielectric material may be in the form of a shaped structure e.g. for use in an anechoic chamber.

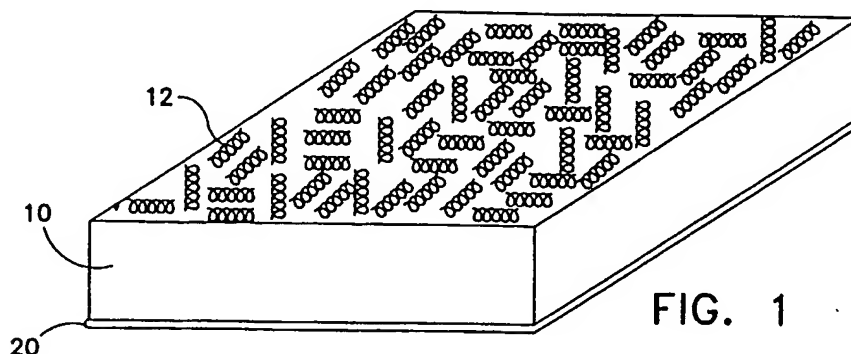


FIG. 1

EP 0 520 677 A1

This invention relates to a chiral absorbing structure, in particular for use in absorbing electromagnetic radiation in the frequency range of 10 megahertz to 100 gigahertz. These are of great importance in providing anti-reflection materials.

Until the discovery of chiral activity, the development of electromagnetic radiation absorbing materials was limited to design variations in ϵ , the permittivity, and μ , the magnetic permeability of the absorbing material. In order to match the impedance of the absorbing material to the free space impedance ϵ_r (relative permittivity) and μ_r (relative permeability) are ideally equal. Practical considerations, however, dictate that this is not possible, with the result that the development of absorbers had been confined to searching for compromise combinations of ϵ_r and μ_r for the absorbing material which produce the best results. There were therefore 2 degrees of freedom in choosing the properties of the absorber.

The introduction of chirality into an absorber produces an extra degree of freedom, expressed by the chirality parameter β , for the choice of properties of the absorbing material.

Chirality is the handedness of an object, that is, the property of an object which renders it non-congruent with its mirror image. Work carried out on chiral absorbing materials indicates that electromagnetic radiation incident on an absorbing material containing chiral inclusions is caused to decompose into left-and right-circularly polarised forms and be scattered through the lossy dielectric material which is host to the chiral inclusions.

According to the present invention there is provided an electromagnetic radiation absorbing structure comprising a structure for absorbing radiation in the range 10 megahertz to 100 gigahertz comprising: (a) a geometrically shaped lossy dielectric medium; and, (b) chiral elements disposed outside the lossy dielectric medium.

The teaching of the prior art is that chirality is only effective when in a lossy host. Tests conducted on chiral elements alone show no absorptive properties. With the structure of the present invention, it has been found that enhanced absorption can be achieved by the addition of chiral elements to the exterior surface of a lossy dielectric material, that is, the chiral elements do not have to be embedded within a lossy dielectric host, but rather may be adjacent it while still enhancing the absorption properties of the overall structure.

The present invention has a number of advantages. One of these is that the manufacture of the overall structure is particularly simple as compared with the absorbers of the "included" type. The control of the dispersion or distribution of chiral elements is particularly easy to achieve as compared with the prior art, in which the distribution of elements is subject to the vagaries of mixing. A second advantage is that where the lossiness of the lossy dielectric is adjusted, or produced by addition e.g. by the steeping of a foam in a suspension or solution of carbon black, the absence of the chiral elements during manufacture is especially advantageous. Generally, the absorption of the lossy dielectric is adjusted by squeezing the foam in order to limit the quantity of carbon black in the foam to the desired quantity before drying. Such a process would not be possible in the presence of chiral elements within the foam.

With the present invention, the chiral elements do not have to be in the lossy part of the absorbing structure, but rather in a non-lossy part, i.e. on the surface of the lossy material and in free space, or embedded in a non-lossy matrix which is adjacent the lossy material. The use of chiral elements in a non-lossy foam for example allows the modular construction of absorbing structures allowing different combinations of β , ϵ_r and μ_r to be produced without committing materials to a combination of all three in a single structure. For the purposes of the present invention, the terms "low loss" and "non-lossy" are intended to refer to a material which has a loss tangent $\tan \delta$ of less than 0.1. The term lossy, in the present context, is intended to refer to a material with a loss tangent $\tan \delta$ of greater than 0.1.

In the present content it is preferable, but not essential that the loss tangent and dielectric constant of the low loss host material are less than 0.01 and 1.25 respectively. In the case of the lossy materials, the loss tangent and dielectric constant are preferably greater than 0.85 and 2.6 respectively at 10 gigahertz. The dielectric constant of the low loss materials may approach such a high value as 1.5 in cases where the material considerations are not purely on the basis of electromagnetic radiation absorption, for example mechanical requirements may dictate that high density foams be used, rather than low density foams. Such high density foams naturally have somewhat higher dielectric constants, and therefore for the same loss tangent, a somewhat higher imaginary dielectric constant component and increased insertion loss. It is regarded that such a component is nevertheless so small as to be insignificant and its effect be unmeasurable.

The present invention is concerned with the production of absorbing structures in the range 10 MHz to 100 GHz; it should be borne in mind that the properties of materials such as lossy dielectrics, in particular the loss tangent and dielectric constant are frequency dependent to the extent that a material or structure whether according to the present invention or not, which exhibits high reflection attenuation at one frequency within the range, may in fact exhibit strong reflections at other frequencies, especially surface

reflection due to the severity of the discontinuity of properties such as permittivity.

It should therefore not be expected that a particular absorbing structure according to the invention will work over the full range claimed, but rather that the present invention provides an instruction for the production of an improved absorber whose properties will be apparent only in parts of the range particular to that absorber. Absorption elsewhere in the range will be exhibited with different combinations of properties.

The invention will further be understood from the following description when taken together with the attached drawings which are given by way of example only and in which:-

Figure 1 shows a first embodiment of the invention;

Figure 2 shows a second embodiment of the invention;

Figure 3 shows a third embodiment of the invention;

Figures 4-9 show results obtained from absorbing structures made according to the invention;

Figure 10 shows a fourth embodiment of the invention; and

Figures 11a, b show alternative arrangements of the embodiment of Figure 10.

Figure 1 shows an embodiment of the invention in which chiral elements 12, in this case, metallic helical springs are superposed on a lossy dielectric material 10 the structure is shown in position over a reflective surface 20, such as a metallic sheet.

Figure 2 shows an alternative embodiment of the invention in which the chiral elements are embedded in a non-lossy foam 13. This foam layer is then superposed on the lossy dielectric medium 10, which in this case comprises a dielectric of increasing permittivity through its depth. This is produced in this instance by the superposition of the layers 14, 15 and 16 of absorbing material of successively increased loss tangent and dielectric constant.

In the embodiments shown, the lossy dielectric medium may be, for instance, from the ECCOSORB LS (T.M.) series produced by Emerson & Cuming. An example of a multi-layer lossy foam is ECCOSORB AN (T.M.), with increased insertion loss through its depth. The chiral elements may be embedded in a non-lossy foam such as ECCOFOAM FPH (T.M.) which has a real permittivity of 1.1 and a loss tangent of the order of 10^{-4} . The non-lossy foam is equally applicable to the embodiment of Figure 1, as is the progressively lossy dielectric assembly shown in Figure 2.

Helices which may be used as chiral elements in the absorber are given, by way of non-limitative example only, in the table below:

HELIX	WIRE DIAMETER (mm)	COIL DIAMETER (mm)	PITCH	LENGTH (mm)
1	0.2	1.0	0.32	2.0
2	0.25	1.2	0.36	2.4
3	0.32	1.6	0.51	6.3
4	0.32	2.0	0.63	5.3
5	0.32	2.5	0.78	4.7

Figure 3 shows a third embodiment of the invention in which the chiral elements are Möbius bands which are superposed on the lossy dielectric material 10.

Figures 4 and 5 show test results obtained with an absorbing structure according to the invention. The lossy dielectric used was one of the ECCOSORB LS (T.M.) range discussed above with an insertion loss of 7.5 dB at 3 gigahertz. The chiral elements used were metallic springs of the following typical dimensions: overall length 4.7mm; wire diameter .32mm; coil diameter 2.5mm; pitch 0.78mm. Such springs are available from TEVEMA under the specification D 10700. The tests were carried out on a 25cm square test piece with a surface density of springs corresponding to 4cm³ of the metal distributed homogeneously over the test piece. As can be seen, the insertion loss of the overall structure is markedly increased as compared with the lossy foam layer alone, an increase in insertion loss of up to 12 dB being achieved.

Figure 6 shows a similar test carried out with a lossy dielectric foam of insertion loss 6.2 dB at 3 gigahertz and metallic springs of the D 10610 specification (TEVEMA). With approximately 1000 chiral elements on the 25cm square test piece an increase in reflection attenuation of between 10 and 14 dB can be noted.

Figure 7 shows the results of a test similar to that carried out above but with a lossy dielectric of approximately 5.7 dB insertion loss at 3 gigahertz and with 1450 springs of the D 10700 specification spread on the 25cm² test piece. As can be seen, the reflection attenuation can be improved by up to 35 dB by the addition of the chiral elements.

Figure 8 shows the results of a similar test with a lossy dielectric of insertion loss 7.3 dB at 3 gigahertz

and chiral elements of the D 10610 specification (TEVEMA). The results are shown for instances where the helices are homogeneously distributed (the middle of the three curves) and where the helices are concentrated towards the centre of the test sample (the lower of the three curves). As can be seen, an improvement in reflection attenuation of up to 15 dB is possible.

In the range 2-26 GHz, a concentration of helices on the lossy dielectric which corresponds to 6×10^{-3} - 10×10^{-3} cm³ of metal per cm² of absorber surface is preferable but not essential.

Figure 9 shows the results of tests carried out on absorbers according to the invention in which the chiral elements are Möbius bands. The lossy dielectric medium was in this instance a lossy foam of 6.25 dB insertion loss at 3 GHz and the Möbius bands were formed of a carbon loaded polycarbonate ("Macrofol" available from Bayer). The Möbius bands are of 20cm length and 5mm wide. With a concentration of 36 rings on the 25cm square test piece, an increase in insertion loss of approximately 7 dB can be achieved.

The lossy dielectric layer may also be shaped into forms which may be cones, wedges, pyramids or oblate spheroids as appropriate, and be made of materials with increasing insertion loss through their depth. Such shaped forms are well-known in the art and commercially available, e.g. ECCOSORB (T.M.) WG-NRL and ECCOSORB (T.M.) VHP-NRL pyramidal absorber available from Grace NV.

Figure 10 shows a fourth embodiment of the invention in which the lossy dielectric medium 30 is shaped to form, in this instance a hollow wedge shown in cross section, for use in an anti-reflection structure, e.g. an anechoic chamber, a wall 33 of which is shown. The structure shown is hollow, although it may be solid and comprises chiral elements on its surface. These elements may either be "naked" or embedded in a non-lossy layer such as a foam 13.

Figures 11a and 11b show alternative embodiments to Figure 10 in which the chiral elements may be on the inside of the lossy dielectric structure, or may be enclosed between two substructures shaped to form the overall structure. In either instance the chiral elements may be embedded in a foam. Alternatively, the chiral elements may be arranged on one or more of the surfaces of the lossy dielectric shown in Figure 11b.

Further improvement in reflection attenuation can be achieved by mounting their structures on a backing surface of ferrite tiles. An alternative to the immersion of a polyurethane foam in a carbon suspension to produce the lossy foam is to use a vinyl composition and incorporate into it carbon fibres. This is of particular interest in the manufacture of geometrically shaped absorbing structures when mechanical considerations are more important than in the case of the sheet absorbers discussed in connection with Figures 1-3.

An alternative to the coil springs or Möbius strips for the chiral elements include a) irregular tetrahedra, b) tapering coil springs (either with constant pitch and reducing diameter, or constant diameter or reducing pitch or a combination of both), c) screws or d) forks with at least three prongs which form an asymmetrical non planar structure. Improvements can also be obtained with mixtures of chiral elements of the same handedness but which give rise to different β values through the absorbing structure.

Such chiral elements, e.g. springs, need not be metallic but it is expected that they will be at least to some extent conductive, and may be of copper, carbonyl iron, brass, steel, a ferromagnetic metal or alloy, ceramic, graphite, or conductive polymer (whether inherently conductive, or conductive by addition).

Claims

1. A structure for absorbing radiation in the range 10 megahertz to 100 gigahertz comprising: (a) a geometrically shaped lossy dielectric medium; and, (b) chiral elements disposed outside the lossy dielectric medium.
2. A structure according to claim 1 wherein the chiral elements are disposed in free space.
3. A structure according to claim 1 wherein the chiral elements are disposed in a non-lossy foam.
4. A structure according to claims 1, 2 or 3 wherein the chiral elements are of one or more of the following types: irregular tetrahedra; helical springs; tapering helical springs; Möbius bands; screws; and forks with at least three non-symmetrically arranged non co-planar prongs.
5. A structure according to any preceding claim wherein the chiral elements are disposed adjacent a surface of the geometrically shaped lossy dielectric medium.

6. A structure according to any preceding claim wherein the chiral elements are disposed between surfaces of two sub-structures of the lossy dielectric material shaped to produce the geometric shaping of the absorbing structure.
- 5 7. A structure according to any preceding claim wherein the chiral elements are metallic.
8. A structure according to any of claims 1-6, wherein the chiral elements are resistive.
9. A structure according to any one of the preceding claims wherein the lossy dielectric medium is tapered in the form of cones, wedges, pyramids or oblate spheroids.
- 10 10. A structure according to any preceding claim wherein the chiral elements are disposed on an internal surface of a hollow geometrically shaped lossy dielectric medium.
- 15 11. A structure according to any one of claims 1 to 9 wherein the forms are hollow.
12. A structure according to any one of claims 1 to 8 wherein the lossy dielectric medium is substantially planar.
- 20 13. A structure according to any preceding claim further comprising a layer of ferrite tiles arranged on the side of the structure remote from the source of incident radiation.

25

30

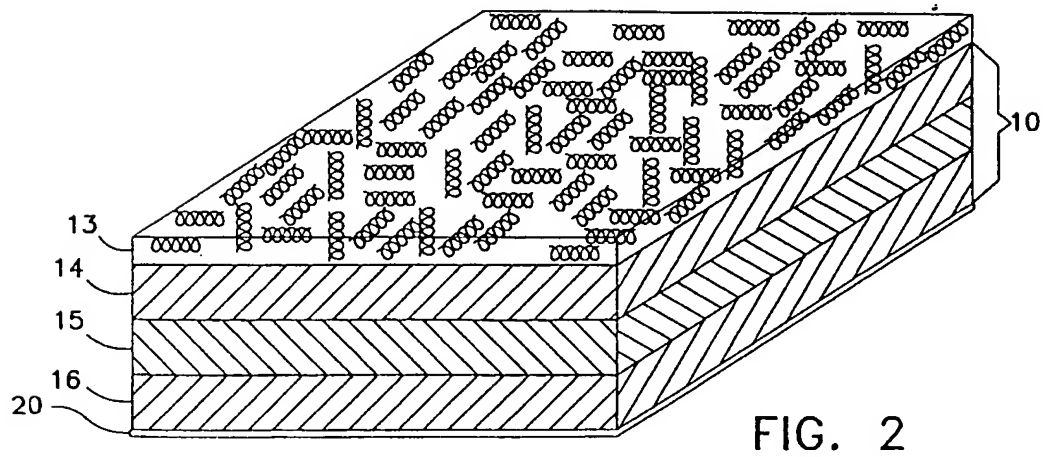
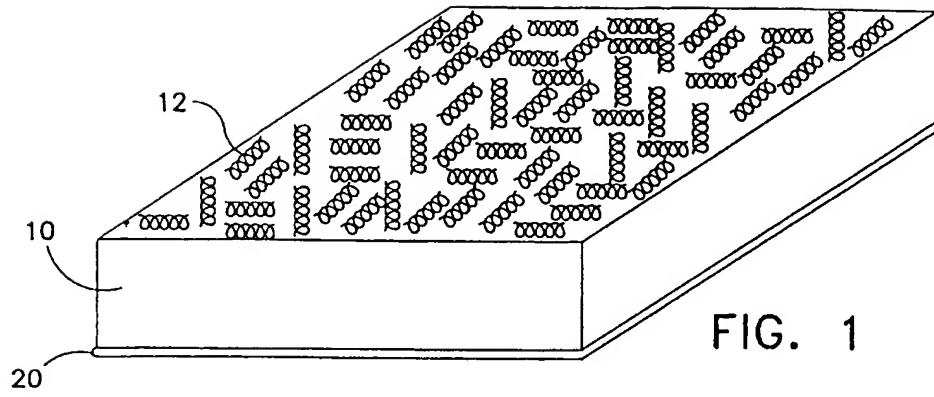
35

40

45

50

55



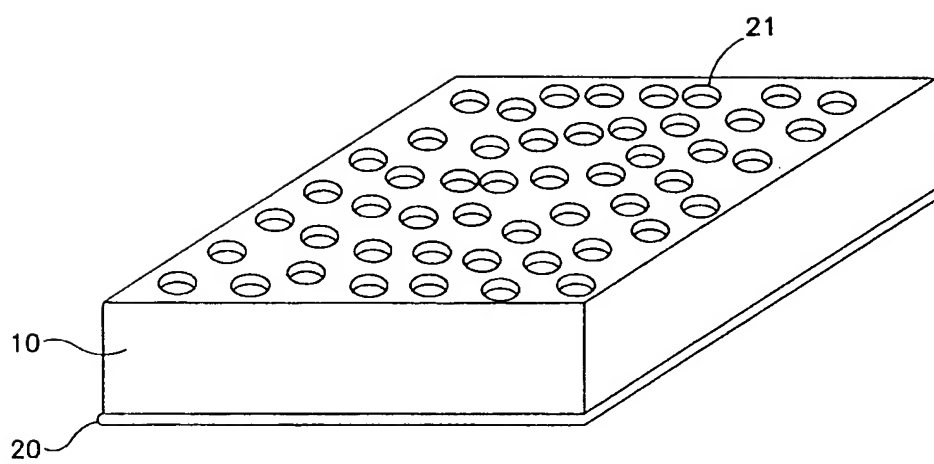


FIG. 3

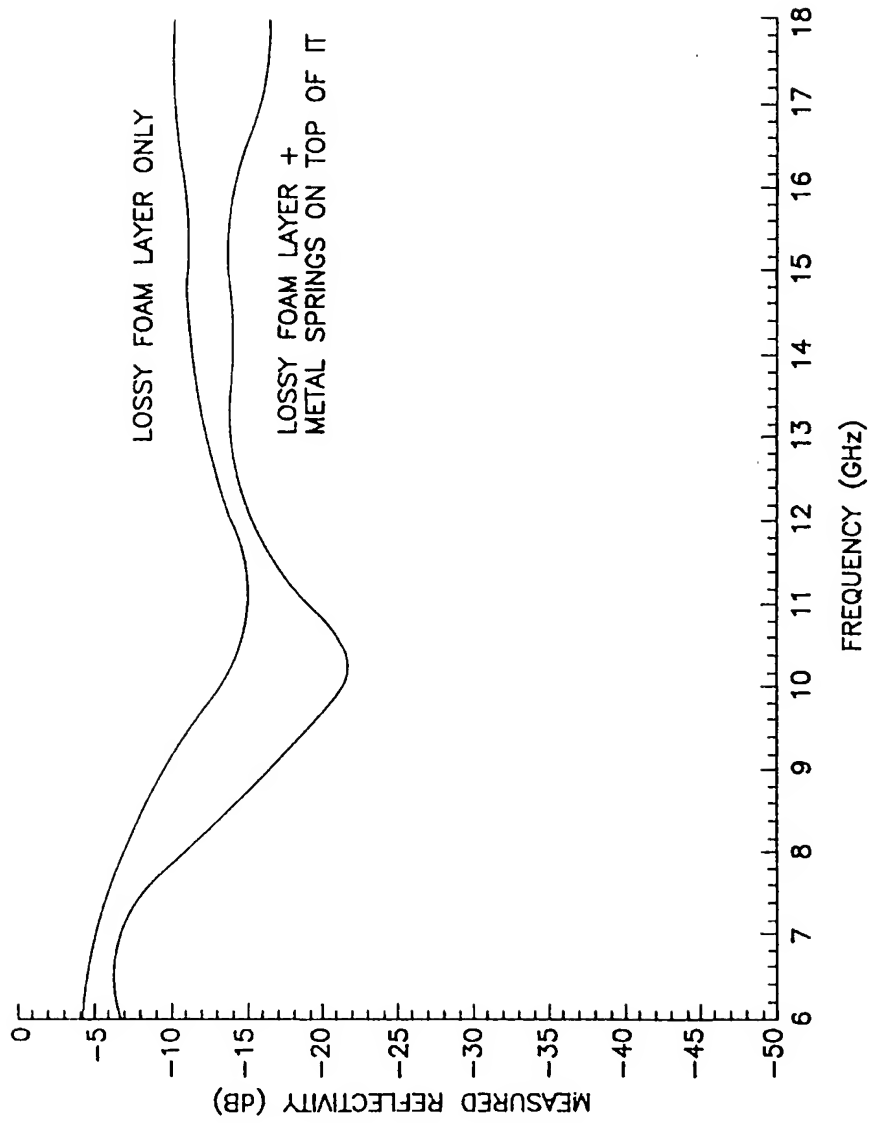


FIG. 4

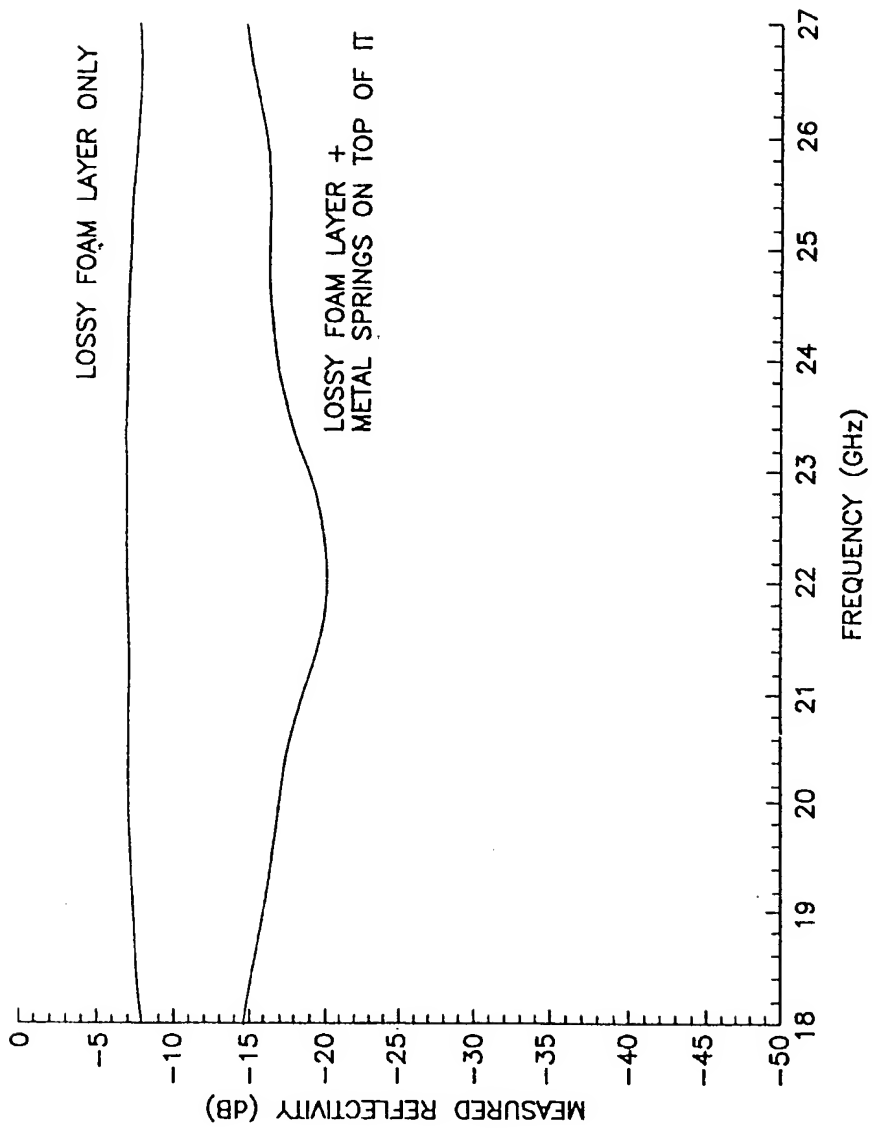


FIG. 5

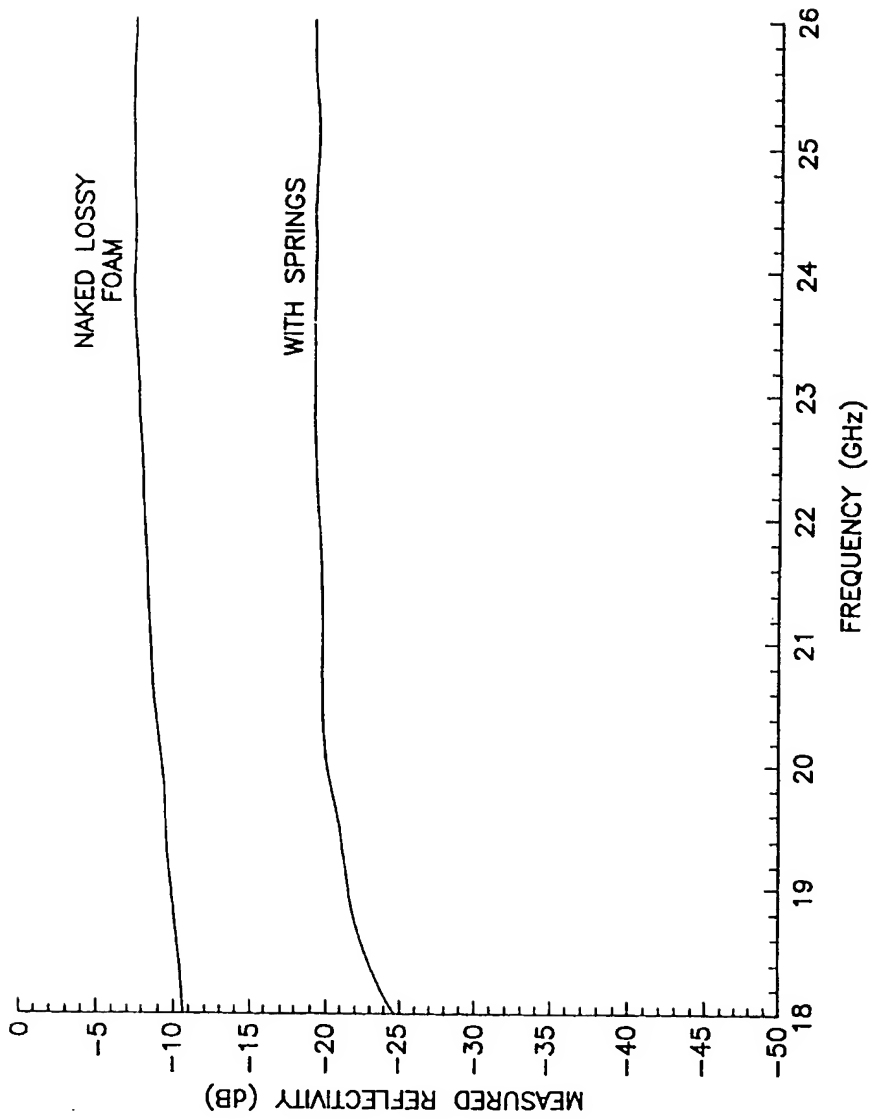


FIG. 6

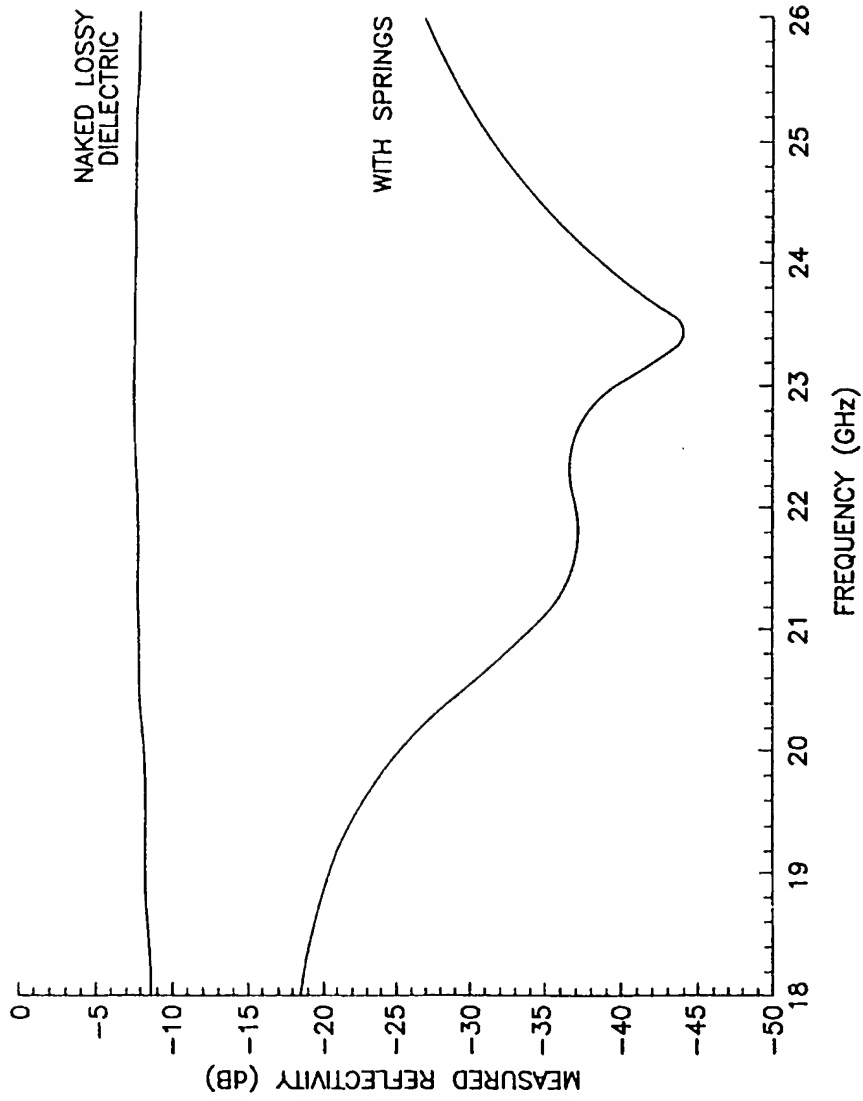


FIG. 7

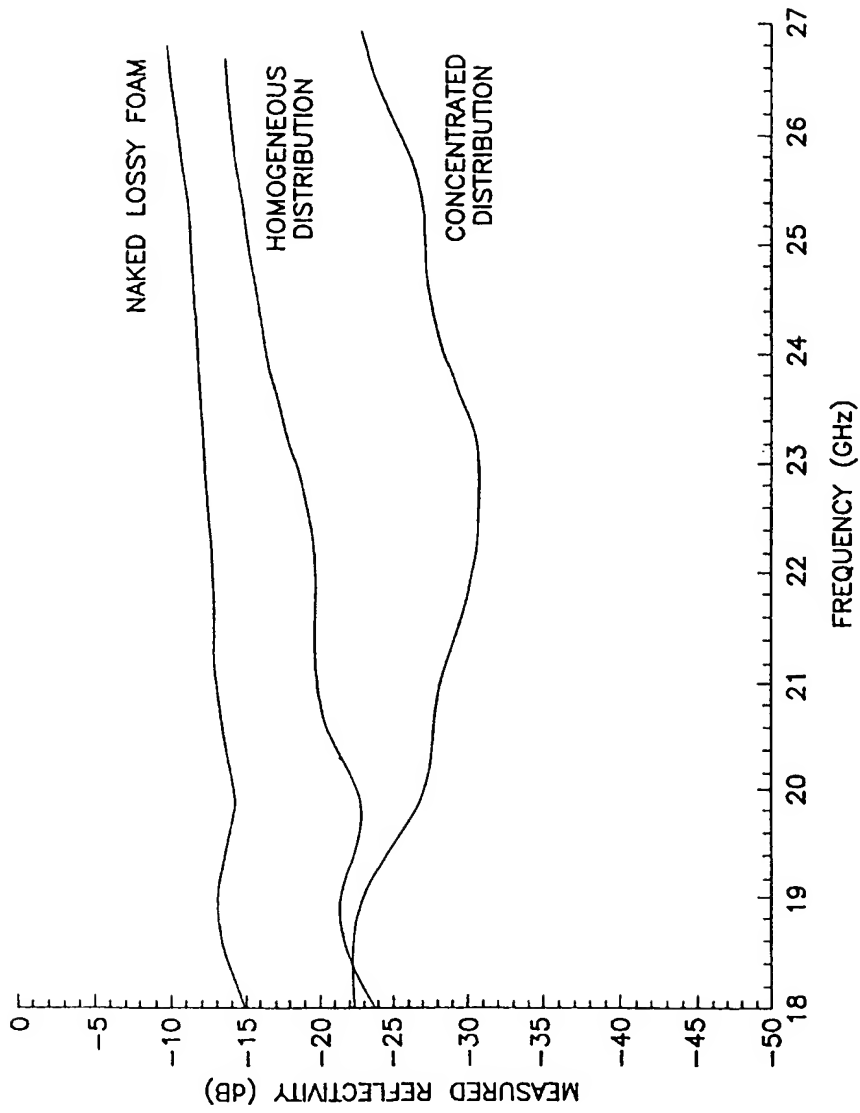


FIG. 8

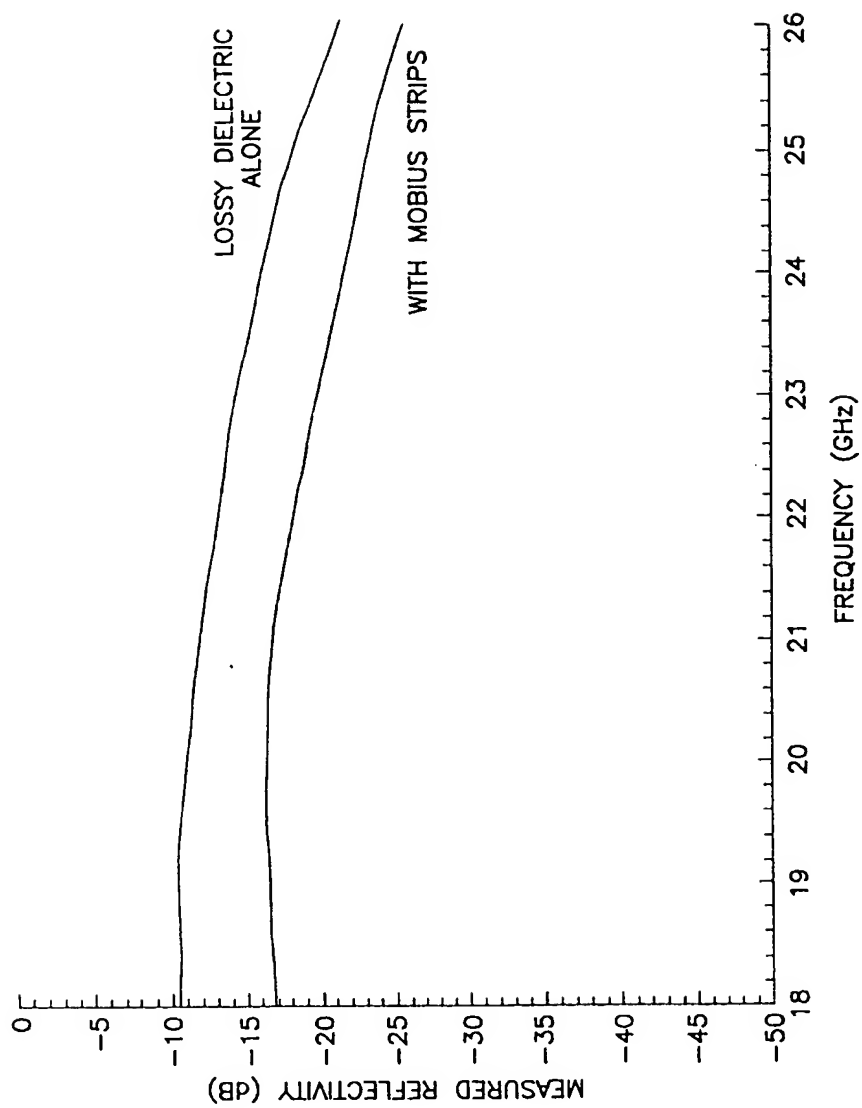


FIG. 9

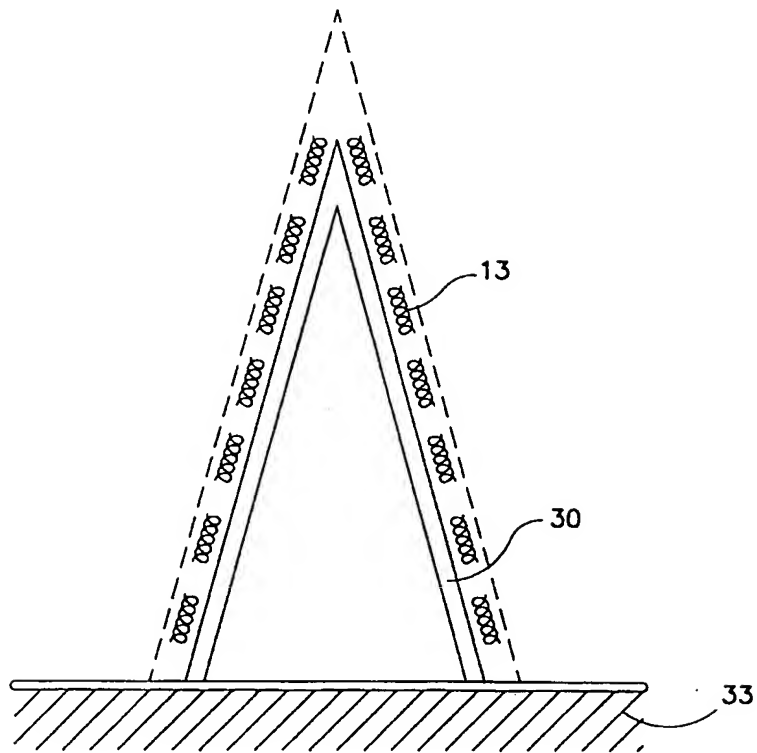


FIG. 10

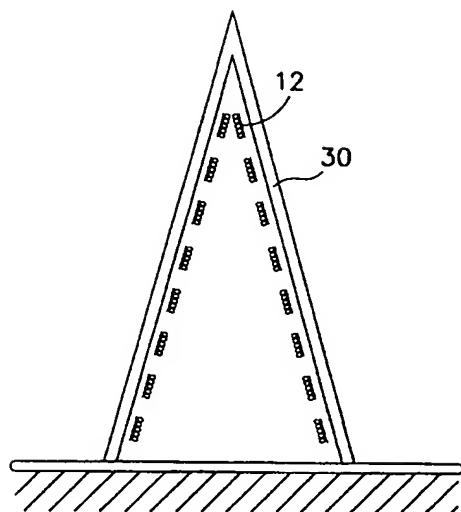


FIG. 11a

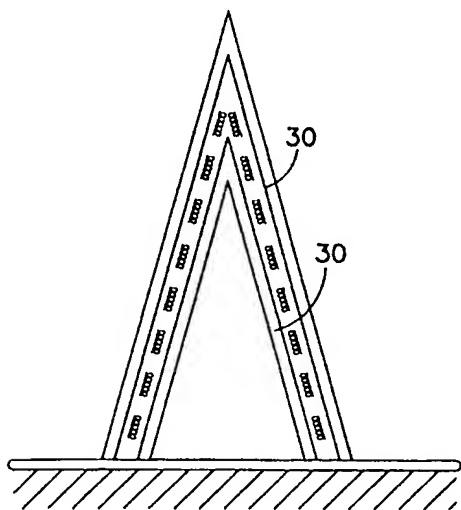


FIG. 11b



European Patent
Office

EUROPEAN SEARCH REPORT

Application Number

EP 92 30 5547

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int. CL.5)
Y	WO-A-9 003 102 (THE PENNSYLVANIA STATE UNIVERSITY) * the whole document *	1-13	H05K9/00
Y	JOURNAL OF WAVE MATERIAL INTERACTION vol. 2, no. 1, January 1987, PHILADELPHIA, PENNSYLVANIA, US pages 71 - 81 V.K. VARADAN ET AL. 'On the possibility of designing anti-reflection coatings using chiral composites' * the whole document *	1-13	
			TECHNICAL FIELDS SEARCHED (Int. CL.5)
			H05K
The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 22 OCTOBER 1992	Examiner TOUSSAINT F.M.A.
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons * : member of the same patent family, corresponding document			